The reference design PMP10215 Rev-D has been built on PMP10215 Rev-B Board
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COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: [No Variations]

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<th>REV: B</th>
<th>SUN REV: Not In VersionControl</th>
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<td>PCB VIEWED FROM BOTTOM SIDE</td>
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